## **Multi-Channel Transcutaneous Cortical Stimulation System**

Contract # N01-NS-7-2365

Progress Report #15

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The goal of this project is the design, fabrication, and testing of a *Multi-Channel Transcutaneous Cortical Stimulation System* to be used in a prototype artificial vision system. During the past 25 years, the development of a neuroprosthesis that could be used to restore visual sensory functions has been an important goal of the Neural Prosthesis Program (NPP) of the National Institute of Disorders and Stroke, National Institutes of Health. Demonstrations of the feasibility of a visual prosthesis have reached the stage in which the NPP is highly motivated to initiate the development of a fully implantable cortical stimulation system which could be used to provide inputs and computer control for hundreds, to over one thousand, implanted cortical electrodes. This is the fifteenth progress report for this project. In this report we describe testing and analysis of the Macor ceramic package.

Figure 1 reviews the basic structure of the ceramic multichip module. In this figure can be seen the location of the glass-to-ceramic seal, located on layer#2. Since the module is comprised of 4 layers of ceramic, there are 3 identically configured glass seals in a complete module.

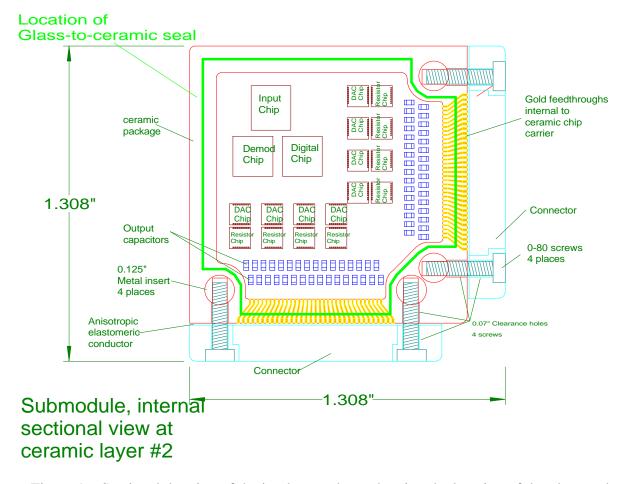


Figure 1 – Sectional drawing of the implant package showing the location of the glass seal.

In order to test the integrity of the glass seal, we fabricated a prototype package comprised of 4 layers of ceramic that were cut in the shape dictated by the package design. These can be seen in Figure 2, below. In the upper right of Figure 2 is shown the CAD tool drawing, from AUTOCAD, that is used as input into the numerically-controlled milling machine.

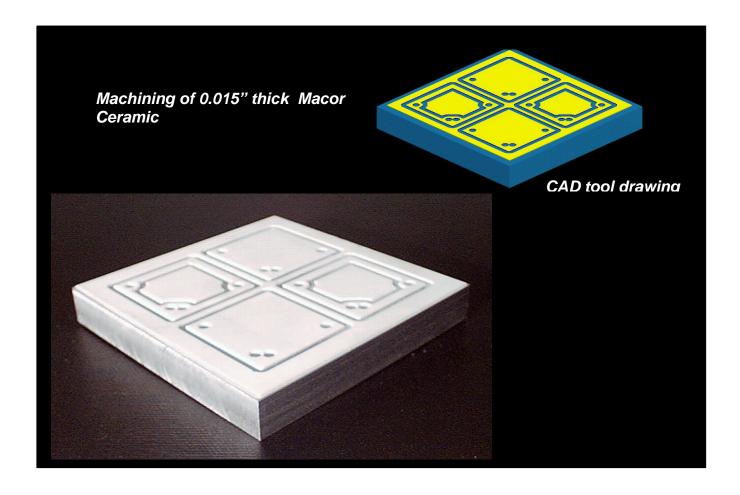


Figure 2 – Machine tool drawing shown next to fully machined ceramic sheets.

The 0.015" thick ceramic sheet is held down on the lapped tool aluminum block using paraffin. The milling machine automatically cuts the shape of all four layers, for a single package, in less than 20 minutes. Once the machining operation is completed, the ceramic is removed from the aluminum block by heating on a hot plate. The paraffin is removed from the ceramic by placing the individual cut pieces, for each layer, on the hot plate, between two layers of absorbent material while weighting down with a steel block. This blotting procedure removes almost all of the paraffin. To insure that no residual paraffin remains, the 4 pieces of ceramic are baked in a 450-degree Celsius furnace for several hours.

The glass is deposited in the green state by mixing the power with a deposition vehicle. This slurry is then loaded into a hypodermic syringe. The syringe is placed in a holder attached to a computer-controlled X-Y table. The input to the table controller is an AUTOCAD file that defines the path to be traced by the syringe. The deposition is controlled by an air-powered syringe system, and the activation and deactivation of the syringe flow is synchronized to the

computer controlled path of the syringe. A typical piece of ceramic, showing the glass in the green state is shown in Figure 3, below.

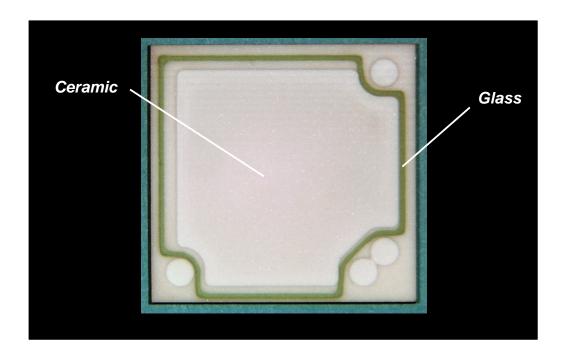


Figure 3 – Glass seal deposited on the ceramic while in the green state.

Then it is prefired at 350 degress Celsius for 2 days. This is necessary to bake off the vehicle prior to firing of the seal. The 4 layers of ceramic, with the green-state seals, are carefully loaded into a stainless steel fixture that uses weight to apply a compressive force to the ceramic layers. The fixture is then placed in the electronically-controlled furnace for the ramped firing profile. The glass is fired at 385 degrees Celsius. The ramped profile includes a dwell time, just below the firing temperature to allow pressure equalization within the package relative to the external environment. This is important to prevent "blow-out" of the seal. A passive, ramped cool-down cycle minimizes the residual stress in the seal.

Package type		
Blank Macor	6 x 10 <sup>-8</sup>	$1 \times 10^{-9}$
Sealed	1 x 10 <sup>-7</sup>	$4 \times 10^{-9}$

Helium bomb = 45 psiBackground =  $10^{-11}$ 

cc-atm/sec

We sent a prototype package to the Mann Foundation for Helium leak testing. In this test, the package is Helium-bombed at 45 PSI. Then the residual Helium emanating from the package is measured. As a control, we used a solid piece of Macor, of approximately the same dimensions as the prototype package. The results from this test are shown in Table 1, above. Note that there is little difference between the solid "blank" Macor piece and the sealed 4-layer package. However, both of these specimens had residual Helium levels that were significantly above the background level. This is disturbing and we investigated this phenomena.

Since the Macor is a composite material, we hypothesized that it might contain microcrevices that could trap Helium beneath the surface. We imaged the solid Macor in the SEM to examine the size and character of the micro-crevices. Figure 4, below shows the surface of the Macor. Indeed the irregular topology and the crevices can be seen.

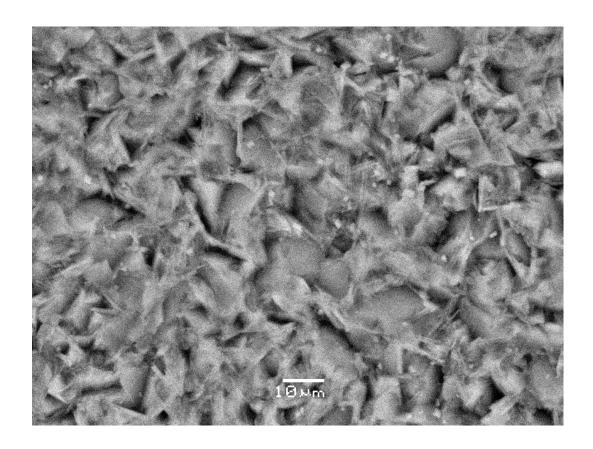


Figure 4 – SEM photograph of the surface of the Macor

However, the size of these crevices is well below the width of the glass seal. The glass seal is approximately 750 microns wide, whereas the average size of the crevices shown in Figure 4 is 10 microns. We then investigated whether the glass melts into the crevices at the interface between the glass and ceramic. Figures 5, 6, 7, and 8, show varying magnifications of the cross section between two ceramic sheets, and the glass seal.

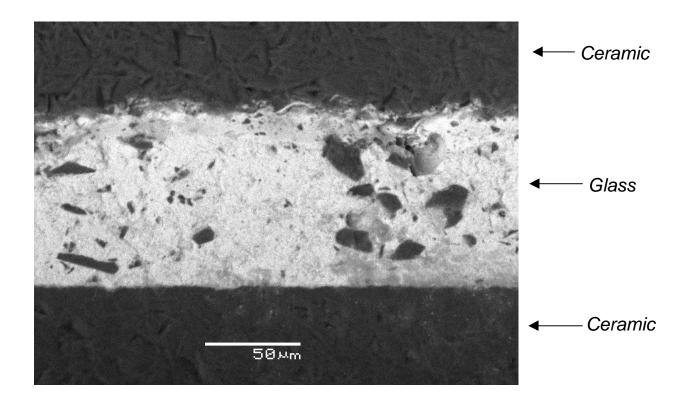


Figure 5 – Interface between two Macor sheets and the Glass seal (500x)

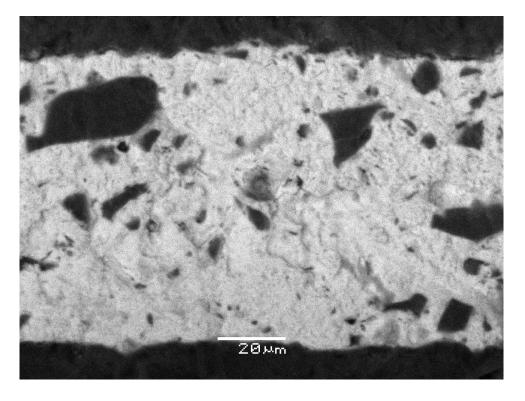


Figure 6 – Interface between two Macor sheets and the Glass seal (900x)

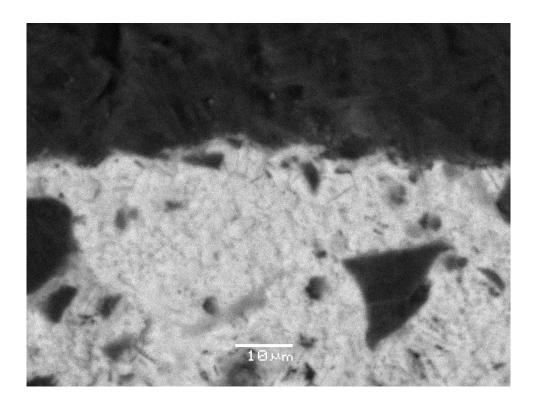


Figure 7 – Interface between upper Macor sheet and the Glass seal (1500x)

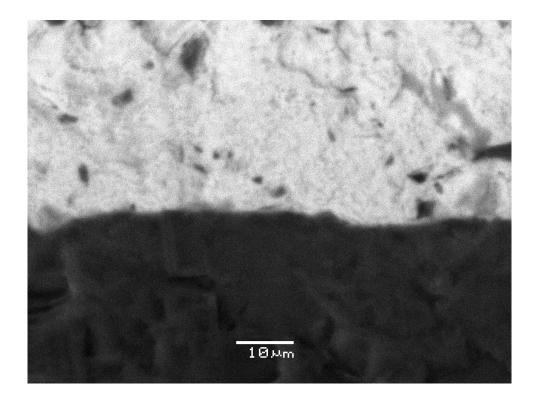


Figure 8 – Interface between lower Macor sheet and the Glass seal (1500x)

As can be seen in the SEM photos above, there is excellent integration between the glass and ceramic. This leads us to believe that the residual Helium seen in the Helium bomb test is an artifact of the measurement method and does not represent a leakage of the sealed package. We are researching, more thoroughly, the characteristics of Macor, through conversations with Corning Inc.

We are also preparing to do a direct measurement of water penetration into a sealed package by using impedance spectroscopy on traces buried within the cavity of the package. We are preparing special metallization patterns that will be electrically accessible by the package feedthroughs.

During the next quarter we intend to test the success of using extended-drain transistors in the output stage of the BLOCK chip in order to correct the small amount of residual imbalance between the anodic and cathodic phases, seen at high electrode voltages.